

# Surge arrester

2-electrode arrester

Series/Type: EHV60-H30SMD Ordering code: B88069X3323T752

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Version: 04

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# 2-electrode arrester EHV60-H30SMD

## **Features**

- Built to automotive standard (IATF 16949)
- Small size
- Fast response time
- High current capability
- Stable performance over service life
- Low capacitance and insertion loss
- High insulation resistance
- Excellent SMD handling
- RoHS-compatible

# **Applications**

## Automotive:

- On-board chargers
- Vehicle charging stations

#### Others:

- LED lighting
- Power supply
- Photovoltaic
- Air conditioning

# **Electrical specifications**

<b>_</b>			
DC spark-over voltage	e <sup>1) 2)</sup>	3000	V
Tolerance		±20	%
Min.		2400	V
Max.		3600	V
Impulse spark-over vo	oltage		
at 100 V/µs	- for 99% of measured values	< 3800	V
	<ul> <li>typical values of distribution</li> </ul>	< 3600	V
at 1 kV/µs	- for 99% of measured values	< 4000	V
	<ul> <li>typical values of distribution</li> </ul>	< 3800	V
at 5 kV/µs	- for 99% of measured values	< 4200	V
	<ul> <li>typical values of distribution</li> </ul>	< 4000	V
Service life			
300 operations	8/20 μs	100	Α
3 operations	8/20 µs	3	kA
1 operation	8/20 µs	5	kA
Insulation resistance at 100 V <sub>DC</sub>		> 1	$G\Omega$
Capacitance at 1 MHz		< 1	pF
Arc voltage at 1 A		~ 45	V
Glow to arc transition	current	< 0.3	Α
Glow voltage at 0.1 A		~ 240	V
AC withstand voltage (1 min) 3)		1500	V
Weight		~ 0.7	g
Operation and storage temperature		-40 <b>+</b> 125	°C
Recommended storage			
- temperature	9	+5 +35	°C
- humidity		45 80	%
- period		≤ 2	years
Climatic category (IEC 60068-1)		40/125/21	

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## 2-electrode arrester

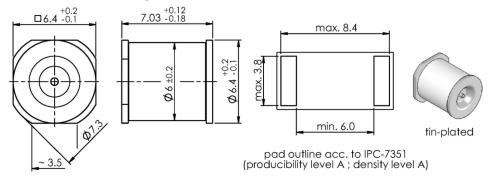
EHV60-H30SMD

Marking, blue positive	EPCOS 3000 YY 3000 - Nominal voltage WW - Calendar week of production YY - Year of production (last digit)	
Certifications	UL 1449 (E319264) C	

<sup>1)</sup> At delivery AQL 0.65 level II, DIN ISO 2859

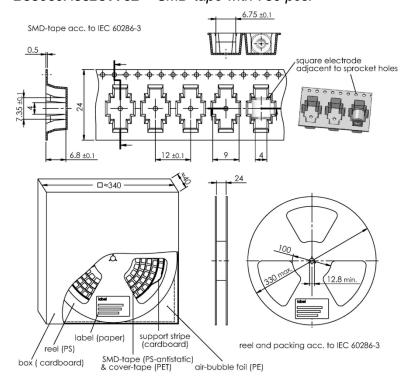
Terms and current waveforms in accordance with: ITU-T Rec. K. 12; IEC 61643-21; 61643-311.

# Dimensional drawing in mm



# Ordering codes and packing advices

B88069X3323**T752** = SMD-tape with 750 pcs.



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<sup>2)</sup> In ionized mode

Test conditions in acc. with MIL-STD-202G at 25 ±5 °C, relative humidity of ≤ 55% and atmospheric pressure 860 ... 1100mbar.

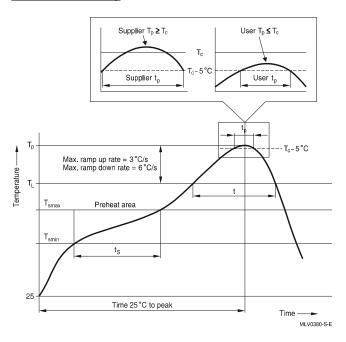


#### 2-electrode arrester

EHV60-H30SMD

## Soldering parameter

#### Reflow soldering



Reflow profile features		Sn- Pb eutectic assembly	Pb-free assembly
Preheat and soak - Temperature min - Temperature max - Time	$T_{smin} \\ T_{smax} \\ t_{smin} \text{ to } t_{smax}$	100 °C 150 °C 60 120 s	150 °C 200 °C 60 180 s
Average ramp-up rate	$T_{\text{smax}}$ to $T_{\text{p}}$	max. 3 °C/ s	max. 3 °C/ s
Liquidous temperature Time at liquidous	T <sub>L</sub>	183 °C 60 150 s	217 °C 60 150 s
Peak package body temperature *, Classification temperature **	$T_p,T_C$	220 235 °C **	245 260 °C **
Time (t <sub>p</sub> ) ** within 5 °C of the specified classification temperature (T <sub>C</sub> )		20 s ***	30 s ***
Average ramp-down rate	T <sub>p</sub> to T <sub>smax</sub>	max. 6 °C/ s	max. 6 °C/ s
Time 25 °C to peak temperature		max. 6 min	max. 8 min

<sup>=</sup> Tolerance for peak profile temperature (T<sub>p</sub>) is defined as a supplier minimum and

Surface mounted components (SMD) may exhibit a temporary increase in the DC spark-over voltage after the solder reflow process. The components will recover within 24 hours. There is no quality defect nor change in protection levels during the temporary change in DC spark-over voltage.

#### Cautions and warnings

- Do not operate surge arresters in power supply networks, whose maximum operating voltage exceeds the minimum spark-over voltage of the surge arresters.
- Electromagnetic fields and ionizing radiation may affect the electrical characteristics of the arrester. The impact of such effects (inductive and capacitive field distortion from adjacent components) must be avoided by appropriate circuit design measures.
- Surge arresters may become hot in the event of longer periods of current stress (burn risk). In the event of overload the connectors may fail or the component may be destroyed.
- If the contacts of the surge arresters are defective, current load can cause sparks and loud noises.
- Surge arresters must be handled with care and must not be dropped.
- Do not continue to use damaged surge arresters.
- The shown SMD pad dimensions represent a safe way to mount the arrester and are a recommendation of the manufacturer. During the reflow process it must be assured that no solder material reduces the insulation distance between the pads below the arrester.
- SMD surge arresters should be soldered within 24 month after shipment.

<sup>\*\* =</sup> For details please refer to JEDEC J-STD-020D

<sup>\*\*\* =</sup> Tolerance for time at peak profile temperature  $(t_p)$  is defined as a supplier minimum and a user maximum.



2-electrode arrester EHV60-H30SMD

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